

SBOS212A - NOVEMBER, 2001

200MHz, CMOS OPERATIONAL AMPLIFIER

FEATURES

UNITY-GAIN BANDWIDTH: 450MHzWIDE BANDWIDTH: 200MHz GBW

HIGH SLEW RATE: 360V/µs
 LOW NOISE: 5.8nV/√Hz

● EXCELLENT VIDEO PERFORMANCE: DIFF GAIN: 0.02%, DIFF PHASE: 0.05° 0.1dB GAIN FLATNESS: 75MHz

• INPUT RANGE INCLUDES GROUND

• RAIL-TO-RAIL OUTPUT (within 100mV)

● LOW INPUT BIAS CURRENT: 3pA

THERMAL SHUTDOWN

SINGLE-SUPPLY OPERATING RANGE: 2.5V to 5.5V

MicroSIZE PACKAGES

APPLICATIONS

- VIDEO PROCESSING
- ULTRASOUND
- OPTICAL NETWORKING, TUNABLE LASERS
- PHOTODIODE TRANSIMPEDANCE AMPS
- ACTIVE FILTERS
- HIGH-SPEED INTEGRATORS
- ANALOG-TO-DIGITAL (A/D) CONVERTER INPUT BUFFERS
- DIGITAL-TO-ANALOG (D/A) CONVERTER OUTPUT AMPLIFIERS
- BARCODE SCANNERS
- COMMUNICATIONS

DESCRIPTION

The OPAx356 series high-speed, voltage-feedback CMOS operational amplifiers are designed for video and other applications requiring wide bandwidth. The OPAx356 is unity gain stable and can drive large output currents. Differential gain is 0.02% and differential phase is 0.05°. Quiescent current is only 8.3mA per channel.

OPAx356 is optimized for operation on single or dual supplies as low as 2.5V (±1.25V) and up to 5.5V (±2.75V). Common-mode input range for the OPAx356 extends 100mV below ground and up to 1.5V from V+. The output swing is within 100mV of the rails, supporting wide dynamic range.

The OPAx356 series is available in single (SOT23-5 and SO-8), and dual (MSOP-8 and SO-8) versions. Multichannel versions feature completely independent circuitry for lowest crosstalk and freedom from interaction. All are specified over the extended –40°C to +125°C range.

OPAx356 RELATED PRODUCTS

| FEATURES | PRODUCT |
|---|---------|
| 200MHz, Rail-to-Rail Output, CMOS, Shutdown | OPAx355 |
| 38MHz, Rail-to-Rail Input/Output, CMOS | OPAx350 |
| 75MHz, Rail-to-Rail Output | OPAx631 |
| 150MHz, Rail-to-Rail Output | OPAx634 |
| Differential Input/Output, 3.3V Supply | THS412x |



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



ABSOLUTE MAXIMUM RATINGS(1)

| Supply Voltage, V+ to V | 7.5V |
|------------------------------------|----------------------------|
| Signal Input Terminals, Voltage(2) | (V–) – 0.5V to (V+) + 0.5V |
| Current ⁽²⁾ | 10mA |
| Output Short-Circuit(3) | Continuous |
| Operating Temperature | 55°C to +150°C |
| Storage Temperature | 65°C to +150°C |
| Junction Temperature | +160°C |
| Lead Temperature (soldering, 10s) | +300°C |

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied. (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current limited to 10mA or less. (3) Short-circuit to ground one amplifier per package.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

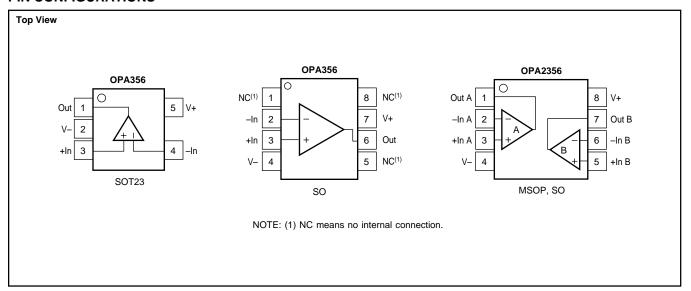
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

| PRODUCT | PACKAGE-LEAD | PACKAGE DESIGNATOR ⁽¹⁾ | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER ⁽²⁾ | TRANSPORT MEDIA, QUANTITY |
|-------------------|--------------|--------------------------------------|-----------------------------------|--------------------|-----------------------------------|---|
| OPA356AIDBV " | SOT23-5 | DBV " | –40°C to +125°C | OAAI " | OPA356AIDBVT OPA356AIDBVR | Tape and Reel, 250 Tape and Reel, 3000 |
| OPA356AID " | SO-8 " | D " | –40°C to +125°C " | OPA356A " | OPA356AID OPA356AIDR | Rails, 100 Tape and Reel, 2500 |
| OPA2356AIDGK " | MSOP-8 | DGK " | –40°C to +125°C " | AYI " | OPA2356AIDGKT OPA2356AIDGKR | Tape and Reel, 250 Tape and Reel, 2500 |
| OPA2356AID | SO-8 " | D " | –40°C to +125°C " | OPA2356A " | OPA2356AID OPA2356AIDR | Rails, 100 Tape and Reel, 2500 |

NOTES: (1) For the most current specifications and package information, refer to our web site at www.ti.com. (2) Models labeled with "T" indicate smaller quantity tape and reel, "R" indicates large quantity tape and reel and "D" indicates rails of specified quantity.

PIN CONFIGURATIONS



ELECTRICAL CHARACTERISTICS: $V_S = +2.7V$ to +5.5V Single Supply

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $+125^{\circ}C$.

At T_A = +25°C, R_F = 604 Ω , R_L = 150 Ω , Connected to V_S/2, unless otherwise noted.

| | | | | A356AIDBV, A A2356AIDGK, | | |
|---|----------------------|---|------------|-----------------------------|------------|-----------------------|
| PARAMETER | | CONDITION | MIN | TYP | MAX | UNITS |
| OFFSET VOLTAGE | | | | | | |
| Input Offset Voltage | Vos | V _S = +5V | | ±2 | ±9 | mV |
| | | Specified Temperature Range | | | ±15 | mV |
| vs Temperature | dV _{os} /dT | Specified Temperature Range | | ±7 | | μ ν/ °C |
| vs Power Supply | PSRR | $V_S = +2.7V$ to +5.5V, $V_{CM} = V_S/2 - 0.15V$ | | ±80 | ±350 | μV/V |
| INPUT BIAS CURRENT | | | | | | |
| Input Bias Current | I _B | | | 3 | ±50 | pА |
| Input Offset Current | I _{OS} | | | ±1 | ±50 | pА |
| NOISE | -03 | | | | | F |
| | | f _ 1MU7 | | E 0 | | nV/√ Hz |
| Input Noise Voltage Density | e _n | f = 1MHz | | 5.8 | | fA/√Hz |
| Current Noise Density | i _n | f = 1MHz | | 50 | | IAV√⊓Z |
| INPUT VOLTAGE RANGE | | | | | | |
| Common-Mode Voltage Range | V_{CM} | | (V–) – 0.1 | | (V+) - 1.5 | V |
| Common-Mode Rejection Ratio | CMRR | $V_S = +5.5V, -0.1V < V_{CM} < +4.0V$ | 66 | 80 | | dB |
| | | Specified Temperature Range | 66 | | | dB |
| INPUT IMPEDANCE | | | | | | |
| Differential | | | | 10 ¹³ 1.5 | | $\Omega \parallel pF$ |
| Common-Mode | | | | 10 ¹³ 1.5 | | $\Omega \parallel pF$ |
| OPEN-LOOP GAIN | | $V_S = +5V, 0.3V < V_O < 4.7V$ | 84 | 92 | | dB |
| | OPA356 | $V_S = +5V, 0.3V < V_O < 4.7V$ | 80 | | | dB |
| | OPA2356 | $V_S = +5V, 0.4V < V_O < 4.6V$ | 80 | | | dB |
| FREQUENCY RESPONSE | | 3 1 7 1 0 1 | | | | - |
| | 4 | C - 11 V - 100mVn n B - 00 | | 450 | | MU |
| Small-Signal Bandwidth | f _{–3dB} | G = +1, $V_O = 100 \text{mVp-p}$, $R_F = 0\Omega$ G = +2, $V_O = 100 \text{mVp-p}$, $R_I = 50\Omega$ | | 450 | | MHz MHz |
| | f_ _{3dB} | _ | | 100 | | MHz |
| | f _{-3dB} | $G = +2$, $V_0 = 100 \text{mVp-p}$, $R_L = 150 \Omega$ | | 170 | | |
| Onin Danaduidab Danadurat | f_ _{3dB} | $G = +2, V_O = 100 \text{mVp-p}, R_L = 1 \text{k}\Omega$ | | 200 | | MHz |
| Gain-Bandwidth Product | GBW | $G = +10, R_L = 1k\Omega$ | | 200 | | MHz |
| Bandwidth for 0.1dB Gain Flatness | 0.100 | $G = +2, V_0 = 100 \text{mVp-p}, R_F = 560 \Omega$ | | 75 | | MHz |
| Slew Rate | SR | $V_S = +5V, G = +2, 4V \text{ Output Step}$ | | 300/–360 | | V/μs |
| Rise-and-Fall Time | | $G = +2$, $V_0 = 200 \text{mVp-p}$, 10% to 90% | | 2.4 | | ns |
| 0 444 77 0 404 | | $G = +2$, $V_0 = 2Vp-p$, 10% to 90% | | 8 | | ns |
| Settling Time, 0.1% | | $V_S = +5V$, $G = +2$, $2V$ Output Step | | 30 | | ns |
| 0.01% | | $V_S = +5V$, $G = +2$, 2V Output Step | | 120 | | ns |
| Overload Recovery Time | | V _{IN} • Gain = V _S | | 8 | | ns |
| Harmonic Distortion | | 0 0 (4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 | | 0.4 | | ID. |
| 2 nd Harmonic | | $G = +2$, $f = 1MHz$, $V_O = 2Vp-p$, $R_L = 200\Omega$ | | -81 | | dBc |
| 3 rd Harmonic | | $G = +2$, $f = 1MHz$, $V_O = 2Vp-p$, $R_L = 200\Omega$ | | -93 | | dBc |
| Differential Gain Error | | NTSC, $R_L = 150\Omega$ | | 0.02 | | % |
| Differential Phase Error | 0040050 | NTSC, $R_L = 150\Omega$ | | 0.05 | | degrees |
| Channel-to-Channel Crosstalk | OPA2356 | f = 5MHz | | -90 | | dB |
| OUTPUT | | | | | | |
| Voltage Output Swing from Rail | | $V_{S} = +5V, R_{L} = 150\Omega, A_{OL} > 84dB$ | | 0.2 | 0.3 | V |
| Voltage Output Swing from Rail | | $V_S = +5V, R_L = 1k\Omega$ | | 0.1 | | V |
| Voltage Output Swing from Rail | | $I_O = \pm 100 \text{mA}$ | | 0.8 | 1 | V |
| Ouput Current, Continuous ⁽¹⁾ | l _o | | ±60 | | | mA |
| Maximum Output Current, Peak(1) | lo | V _S = +5V | ±100 | | | mA |
| Maximum Output Current, Peak ⁽¹⁾ | Io | V _S = +3V | | ±80 | | mA |
| Short Circuit Current | | | | +250/-200 | | mA |
| Closed-Loop Output Impedance | | f < 100kHz | | 0.02 | | Ω |
| POWER SUPPLY | | | | | | |
| Specified Voltage Range | V_S | | 2.7 | | 5.5 | V |
| Operating Voltage Range | | | | 2.5 to 5.5 | | V |
| Quiescent Current (per amplifier) | ΙQ | $V_{S} = +5V, I_{O} = 0$ | | 8.3 | 11 | mA |
| | | Specified Temperature Range | l | | 14 | mA |



ELECTRICAL CHARACTERISTICS: $V_S = +2.7V$ to +5.5V Single Supply (Cont.)

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $+125^{\circ}C$.

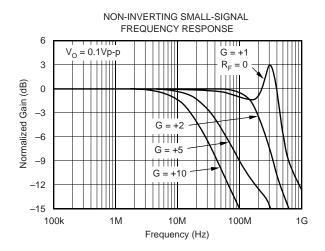
At T_A = +25°C, R_F = 604 Ω , R_L = 150 Ω , Connected to V_S/2, unless otherwise noted.

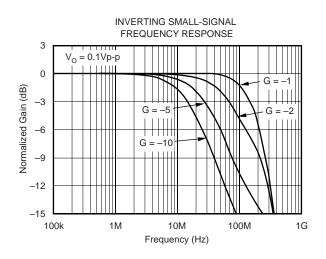
| | | OP OP | | | |
|---------------------------------|-----------|-------------|-----|-----|-------|
| PARAMETER | CONDITION | MIN | TYP | MAX | UNITS |
| THERMAL SHUTDOWN | | | | | |
| Junction Temperature | | | | | |
| Shutdown | | | 160 | | °C |
| Reset from Shutdown | | | 140 | | °C |
| TEMPERATURE RANGE | | | | | |
| Specified Range | | -40 | | 125 | °C |
| Operating Range | | - 55 | | 150 | °C |
| Storage Range | | -65 | | 150 | °C |
| Thermal Resistance $	heta_{JA}$ | | | | | °C/W |
| SOT23-5, MSOP-8 | | | 150 | | °C/W |
| SO-8 | | | 125 | | °C/W |

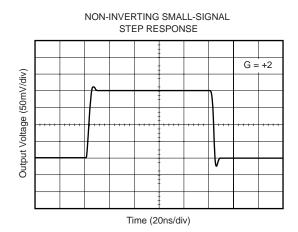
NOTES: (1) See typical characteristic "Output Voltage Swing vs Output Current".

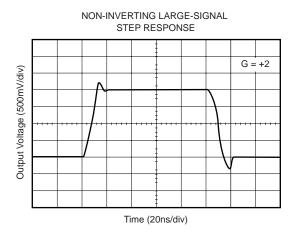


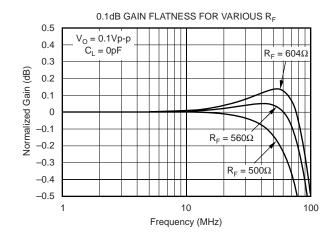
TYPICAL CHARACTERISTICS

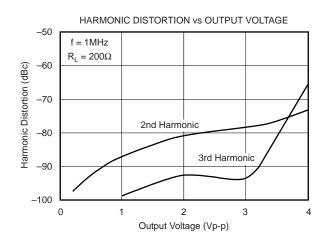




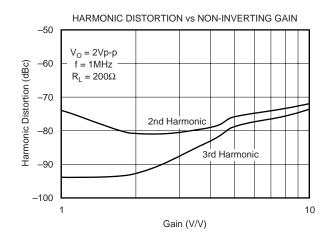


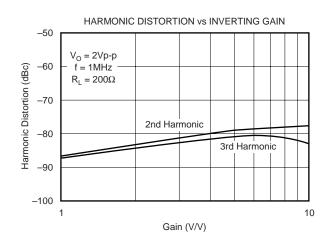


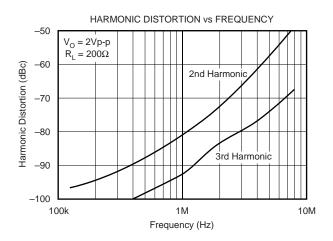


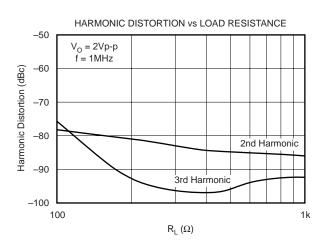


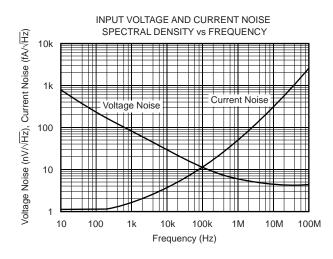


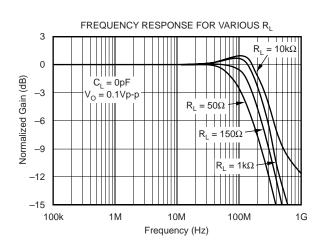




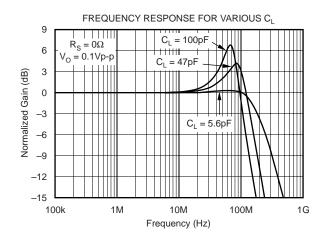


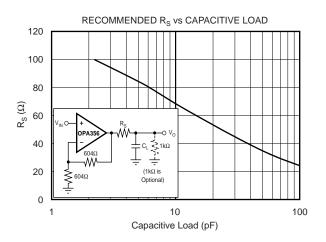


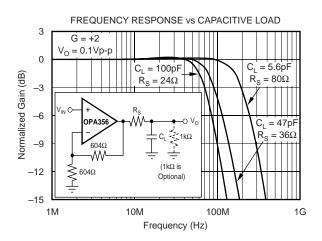


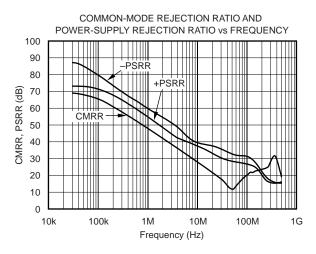


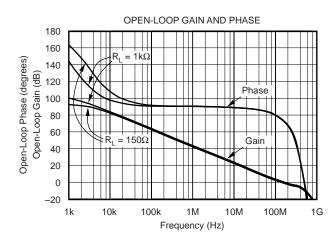


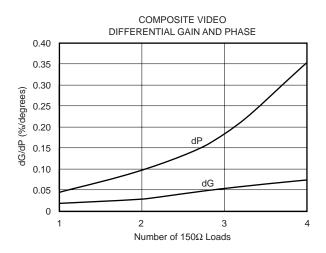


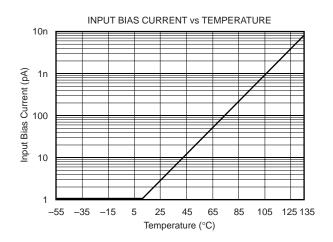


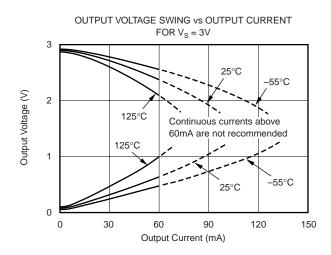


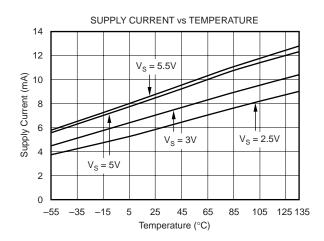


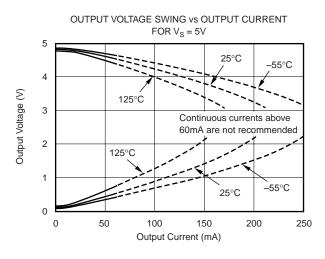


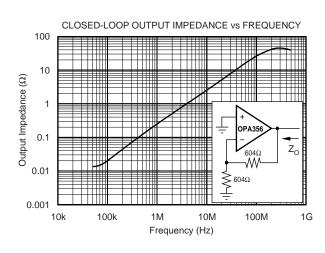


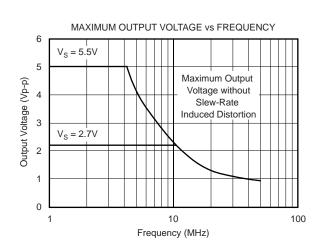




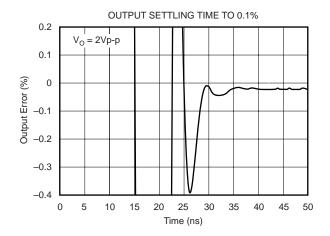


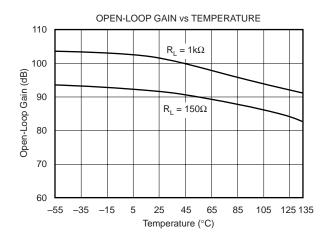


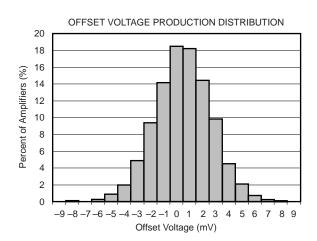


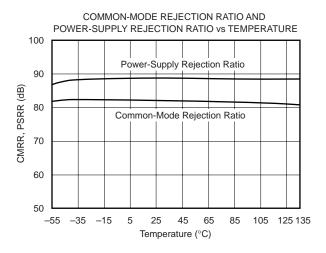


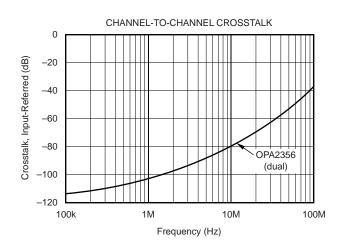














APPLICATIONS INFORMATION

The OPAx356 series is a CMOS, high-speed, voltage feed-back, operational amplifier designed for video and other general-purpose applications. It is available as a single or dual op amp.

The amplifier features a 200MHz gain bandwidth and $360V/\mu s$ slew rate, but it is unity-gain stable and can be operated as a +1V/V voltage follower.

Its input common-mode voltage range includes ground, allowing the OPAx356 to be used in virtually any single-supply application up to a supply voltage of +5.5V.

PCB LAYOUT

Good high-frequency PC board layout techniques should be employed for the OPAx356. Generous use of ground planes, short direct signal traces, and a suitable bypass capacitor located at the V+ pin will assure clean, stable operation. Large areas of copper also provide a means of dissipating heat that is generated within the amplifier in normal operation.

Sockets are definitely not recommended for use with any high-speed amplifier.

A $10\mu F$ ceramic bypass capacitor is the minimum recommended value; adding a $1\mu F$ or larger tantalum capacitor in parallel can be beneficial when driving a low-resistance load. Providing adequate bypass capacitance is essential to achieving very low harmonic and intermodulation distortion.

OPERATING VOLTAGE

The OPAx356 is specified over a power-supply range of +2.7V to +5.5V (±1.35 to $\pm2.75V$). However, the supply voltage may range from +2.5V to +5.5V ($\pm1.25V$ to $\pm2.75V$). Supply voltages higher than 7.5V (absolute maximum) can permanently damage the amplifier.

Parameters that vary significantly over supply voltage or temperature are shown in the "Typical Characteristics" section of this data sheet.

OUTPUT DRIVE

The OPAx356 output stage is capable of driving a standard back-terminated 75 Ω video cable. By back-terminating a transmission line, it does not exhibit a capacitive load to its driver. A properly back-terminated 75 Ω cable does not appear as capacitance; it presents only a 150 Ω resistive load to the OPAx356 output.

The output stage can supply high short-circuit current (typically over 200mA). Therefore, an on-chip thermal shutdown circuit is provided to protect the OPAx356 from dangerously high junction temperatures. At 160°C, the protection circuit will shut down the amplifier. Normal operation will resume when the junction temperature cools to below 140°C.

NOTE: It is not recommended to run a continuous DC current in excess of ± 60 mA. Refer to the graph of "Output Voltage Swing vs Output Current", shown in the "Typical Characteristics" section of this data sheet.

INPUT AND ESD PROTECTION

All OPAx356 pins are static protected with internal ESD protection diodes tied to the supplies, as shown in Figure 1.

These diodes will provide overdrive protection if the current is externally limited to 10mA by the source or by a resistor.

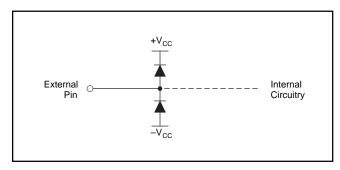
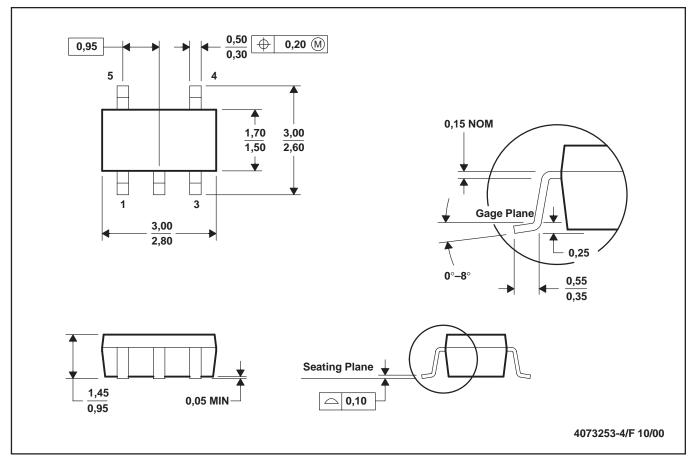


FIGURE 1. Internal ESD Protection.

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE

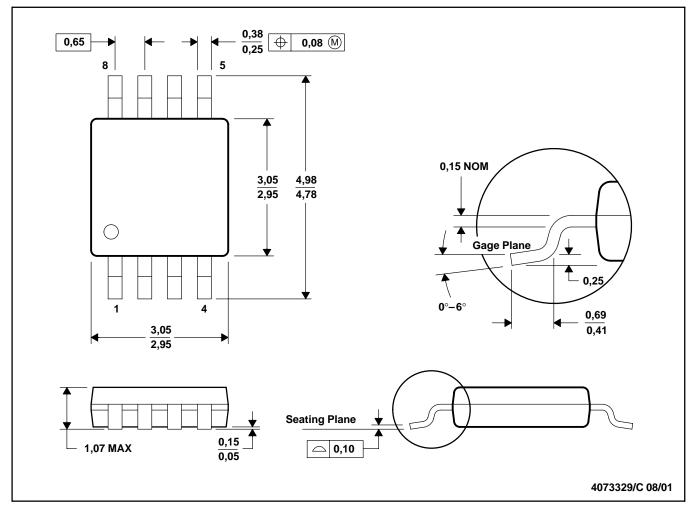


NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-178

DGK (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

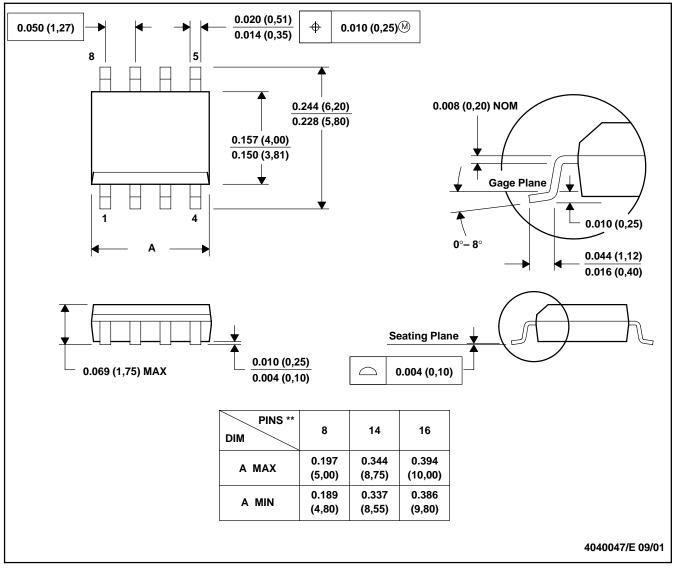
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-187



D (R-PDSO-G**)

8 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

www.ti.com 25-Apr-2022

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|---------------------|--------------|----------------------|---------|
| OPA2356AID | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OPA 2356A | Samples |
| OPA2356AIDG4 | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OPA 2356A | Samples |
| OPA2356AIDGKR | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | Call TI NIPDAUAG | Level-2-260C-1 YEAR | -40 to 125 | AYI | Samples |
| OPA2356AIDGKT | ACTIVE | VSSOP | DGK | 8 | 250 | RoHS & Green | Call TI NIPDAUAG | Level-2-260C-1 YEAR | -40 to 125 | AYI | Samples |
| OPA2356AIDGKTG4 | ACTIVE | VSSOP | DGK | 8 | 250 | RoHS & Green | Call TI | Level-2-260C-1 YEAR | -40 to 125 | AYI | Samples |
| OPA2356AIDR | ACTIVE | SOIC | D | 8 | 2500 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OPA 2356A | Samples |
| OPA356AID | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OPA 356A | Samples |
| OPA356AIDBVR | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OAAI | Samples |
| OPA356AIDBVT | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OAAI | Samples |
| OPA356AIDBVTG4 | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OAAI | Samples |
| OPA356AIDG4 | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OPA 356A | Samples |
| OPA356AIDR | ACTIVE | SOIC | D | 8 | 2500 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 125 | OPA 356A | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

PACKAGE OPTION ADDENDUM

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Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF OPA2356, OPA356:

Automotive : OPA356-Q1

Enhanced Product : OPA2356-EP

NOTE: Qualified Version Definitions:

Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

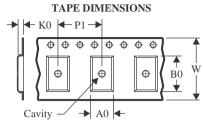
• Enhanced Product - Supports Defense, Aerospace and Medical Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

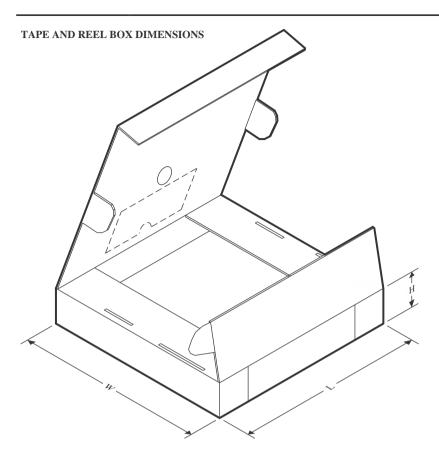
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| OPA2356AIDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| OPA356AIDBVR | SOT-23 | DBV | 5 | 3000 | 178.0 | 8.4 | 3.3 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| OPA356AIDBVT | SOT-23 | DBV | 5 | 250 | 178.0 | 8.4 | 3.3 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| OPA356AIDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |

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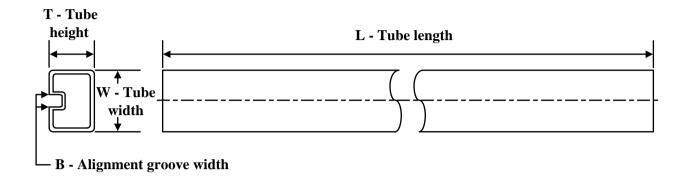
*All dimensions are nominal

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|---|--------------|---------------------------------------|---|------|-------------|------------|-------------|
| Device | Package Type | Package Type Package Drawing Pins SPQ | | SPQ | Length (mm) | Width (mm) | Height (mm) |
| OPA2356AIDR | SOIC | D | 8 | 2500 | 356.0 | 356.0 | 35.0 |
| OPA356AIDBVR | SOT-23 | DBV | 5 | 3000 | 445.0 | 220.0 | 345.0 |
| OPA356AIDBVT | SOT-23 | DBV | 5 | 250 | 445.0 | 220.0 | 345.0 |
| OPA356AIDR | SOIC | D | 8 | 2500 | 356.0 | 356.0 | 35.0 |

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| OPA2356AID | D | SOIC | 8 | 75 | 506.6 | 8 | 3940 | 4.32 |
| OPA2356AIDG4 | D | SOIC | 8 | 75 | 506.6 | 8 | 3940 | 4.32 |
| OPA356AID | D | SOIC | 8 | 75 | 506.6 | 8 | 3940 | 4.32 |
| OPA356AIDG4 | D | SOIC | 8 | 75 | 506.6 | 8 | 3940 | 4.32 |

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